nexperia

Final Product Change Notification

201803001F01

Issue Date: 24-Mar-2018 Effective Date: 06-Jul-2018

Here's your personalized quality information concerning products Digi-Key purchased from Nexperia.

For detailed information we invite you to view this notification online



Change Category

[] Wafer Fab Process

[] Wafer Fab Materials

[] Wafer Fab Location

Release of second source mold compound for MOSFET product types in SOT457

[] Assembly	[] Product Marking	[] Test	[] Design
Process		Location	
[X] Assembly	[] Mechanical Specification	n[]Test	[] Errata
Materials		Process	
[] Assembly	[]	[] Test	[] Electrical
Location	Packing/Shipping/Labeling	Equipment	spec./Test
			coverage

Details of this Change

Scheduled change affects small signal MOSFET product types in SOT457 (SC-74) package only. A second source mold compound will be introduced for the affected products.

Old product: current mold compound supplier is used for production Changed product: current and new second source mold compound supplier is used for production

The design and materials of all other components will remain unchanged, i.e. no change of lead frame, die, die attach, and bond wire. Reliability qualification and full electrical characterization over temperature has been performed. No change on thermal behavior or mechanical dimensions. Electrical parameters remain unchanged (in specification and with the same distribution).

Why do we Implement this Change

Following Nexperia company policy and second source material availability, a new second source mold compound will be added to the BOM. The second source is already a well-established mold compound supplier for Nexperia discrete semiconductor products.

Identification of Affected Products

Changed products can be identified by date code after implementation.

Product Availability

Sample Information Samples are available upon request Latest sample request date for PCN samples is 23-Apr-2018. Production Planned first shipment 16-Jul-2018 No impact to the products' functionality anticipated. **Data Sheet Revision** No impact to existing datasheet **Disposition of Old Products**

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 23-Apr-2018. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact Nexperia "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

e-mail address DiscrQA.Helpdesk.GA-Products@nexperia.com

At Nexperia B.V. we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 70 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

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Affected Part Numbers

PMN30UNX PMN52XPX PMN40ENEX PMN30XPX PMN70XPX PMN16XNEX PMN30UNEX